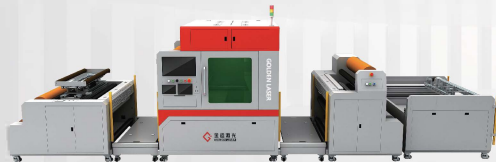


11

薄膜胶带激光模切

Laser Die Cutter for Film and Tape

LC-1250



- 设备尺寸 Dimensions: 1.4m×2.33m×2.1m
- 因设备升级，外观与尺寸可能发生变化
Appearance and dimension may change due to upgrading

产品介绍 Introduction

薄膜胶带激光模切系统LC-1250，适用于大幅面薄膜胶带材料模切加工，实现高精度激光模切，图案精准无偏差，打孔、切割效率高。
Laser die cutting system LC-1250 is designed for large format film and tape materials processing. It delivers high precision laser die cutting, ensuring accurate, deviation-free patterns, and high efficiency in perforating and cutting.

设备特点 Features

- 超大加工幅面，搭配高速激光切割系统，生产效率大幅提升。
The extra-large working area, coupled with a high-speed laser cutting system, significantly enhances production efficiency.
- 能根据不同薄膜胶带特性与加工需求，灵活调整切割参数，轻松应对各类复杂图形的高精度打孔切割。
It can flexibly adjust cutting parameters according to the characteristics and processing requirements of different film and tape materials, easily handling high precision perforating and cutting of various complex designs.

主要应用 Applications



12

精密激光切割

Precision Laser Cutter

JMS2TJG5050DT-M



- 设备尺寸 Dimensions: 1.9m×1.8m×2m
- 因设备升级，外观与尺寸可能发生变化
Appearance and dimension may change due to upgrading

产品介绍 Introduction

精密激光模切系统JMS2TJG5050DT-M，采用封闭式设计，安全防护、防尘降噪一步到位，准直切割与振痕打标可任意转换，灵活应对不同加工需求。针对显示屏、电子纸等需要高精度切割的行业，实现高效产出，提升良品率，提高生产效率。

Precision laser diecutting system JMS2TJG5050DT-M features a fully enclosed design, providing comprehensive safety protection, dust prevention, and noise reduction. It seamlessly switches between plotter cutting and galvanometer marking, flexibly adapting to diverse processing requirements. This system is tailored for industries demanding high-precision cutting, such as displays and e-paper, achieving high-efficiency output, improving yield rates, and boosting production efficiency.

设备特点 Features

- 准直切割与振痕打标可任意转换，适配不同工艺与加工要求，大幅提升切割效率和成品精度。
Seamless switching between plotter cutting and galvanometer marking accommodates diverse processes and machining requirements, significantly enhancing cutting efficiency and product precision.
- 封闭式设计隔绝激光辐射，阻挡灰尘，保障操作人员安全。
The enclosed design isolates laser radiation and blocks dust, ensuring operator safety.

主要应用 Applications

